221. Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per Table 1.
222. These assemblies are ESD sensitive. ESD precautions shall be observed.
223. These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
224. These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label text</th>
</tr>
</thead>
<tbody>
<tr>
<td>001</td>
<td>UCC28630 Ref Des</td>
</tr>
<tr>
<td>002</td>
<td>Not Applicable</td>
</tr>
</tbody>
</table>

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: PMP9208</th>
<th>REV: E2</th>
<th>SUN REV: Not In VersionControl</th>
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</thead>
<tbody>
<tr>
<td>IGNORE -&gt; Top Overlay</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

PLOT NAME = Top Assembly Drawing
GENERATED : 15/04/2014 12:25:27

TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANTS: 001

<table>
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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #</th>
<th>REV</th>
<th>SUN REV</th>
<th>BOTTOM OVERRIDEBY</th>
<th>PLOT NAME</th>
<th>GENERATED</th>
<th>TEXAS INSTRUMENTS</th>
</tr>
</thead>
</table>
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